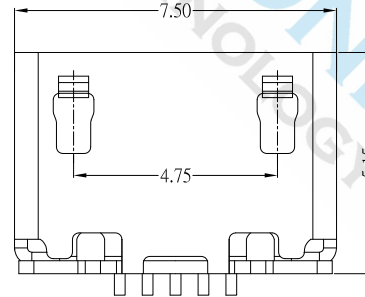


RECOMMENDED PCB LAYOUT



**SPECIFICATIONS**

**Electrical:**

- 1.Current Rating: 1.0A
- 2.Voltage Rating: 30V
- 3.Contact Resistance: 30 mΩ Max
- 4.Dielectric Withstanding Voltage: 100 V AC Min
- 5.Insulation Resistance: 100 MΩ Min

**Mechanical:**

- 1.Connector Mate and Unmate Force
  - 1.1 Mate force: 35N (Max)
  - 1.2 Unmate force: 10N(Min)

**Material:**

- 1.Housing: LCP,UL 94V-0
- 2.Contact: Brass
- 3.Shell: SUS

**Finish:**

- 1.Contact: Plated Gold in Mating Area ;  
Gold Plated on Solder Balls  
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

DIMENSIONS TOLERANCE METRIC .0±0.30 .00±0.20 .000±0.10 ANG.=±2°	單位(UNITS)	MM	處理(FINISH)	SEE NOTE	審核(CH'K)	Calvin	圖名(NAME) MICRO B 90度 四腳2.0 DIP (前7.2 後6.6) 4.0柱 平口	WISCONN Technology Co., Ltd Tel:02-2790-1979 Fax:02-2790-1569								
	數量(QT'Y)	N/A	繪圖(DRAW)	Johnson	核准(APP'D)	Selena								料號(PART NUMBER)	WMRU2-5-xxR3D8P3F	
	材料(MT'L)	SEE NOTE	設計(DE'N)	Mike	日期 DATE)	MAY.05.2016	圖號(DRAW NUMBER)	T002	比例 (SCALE)	1/1	圖紙 (SIZE)	A4	頁次 (SHEET)	1	版次 (REV.)	A
								圖檔(FILE NAME .DWG)								